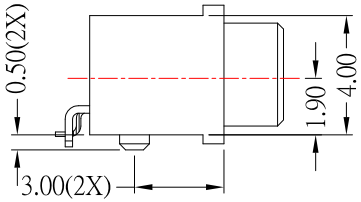
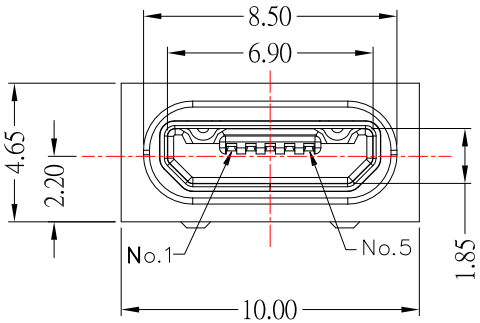
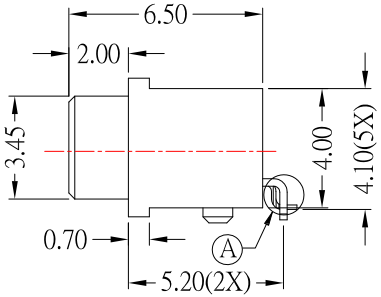
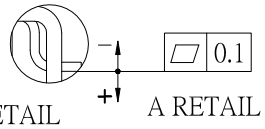
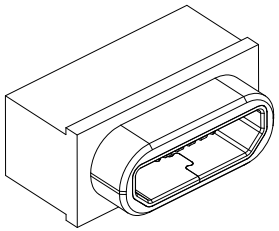


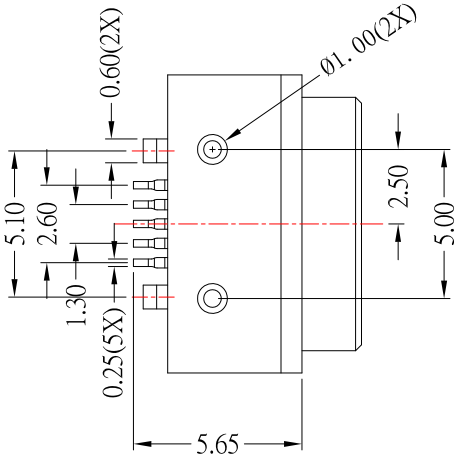


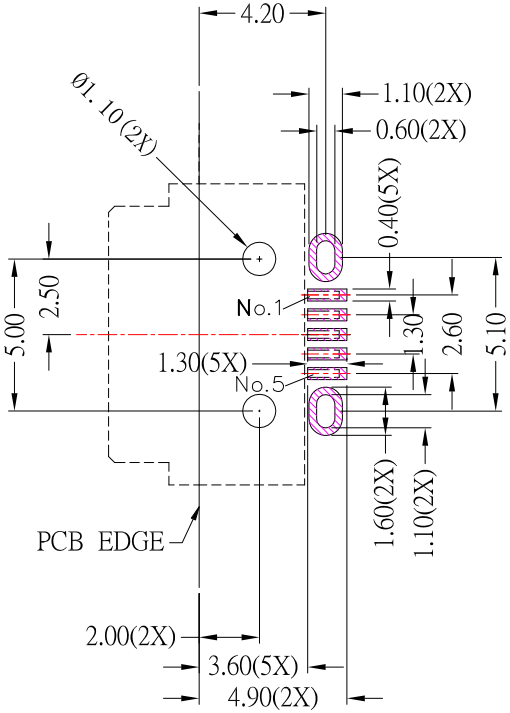






Waterproof Level : IPX 7





PCB LAYOUT MOUNTING PATTERN
TOP VIEW

Material:

1.Housing: PA10T

2.Contact: Phosphor Bronze

3.Shell: SUS

4.Cover: LCP

Finish:

1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls
Nickel under plated overall

2.Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE
2	更新材質	Jack	112416
1	更新為A0版	Jack	032816

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS MM

DRAWN BY: Jack Lu	DATE 11/24/16	MAT'L	
CHECKED BY: Jacky Chen	DATE 11/24/16	FINISH	
APPROVED BY: Tony Kao	DATE 11/24/16	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR		
MODLE	MICRO USB B TYPE SMT 防水型		
DWG NO.	MRUSB-5B-WP2-S052	SIZE	A4
PART NO.	MRUSB-5B-WP2-S052	VER	A1